# 1-178316-5 ACTIVE

#### Dynamic Series | Dynamic 3000 Series

TE Internal #: 1-178316-5

PCB Mount Header, Vertical, Wire-to-Board, 6 Position, .15 in [3.81

mm] Centerline, Fully Shrouded, Tin, Through Hole - Solder,

Dynamic 3000 Series

View on TE.com >



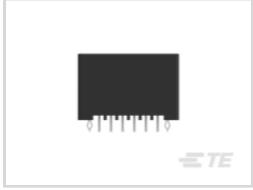
Connectors > PCB Connectors > PCB Headers & Receptacles > Header Assembly: Wire-to-Board, 15A, gold or tin plated











Connector System: Wire-to-Board

Number of Positions: 6
Number of Rows: 1

Centerline (Pitch): 3.81 mm [.15 in]
PCB Mount Orientation: Vertical

All Header Assembly: Wire-to-Board, 15A, gold or tin plated (120)

### **Features**

#### **Product Type Features**

Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Number of Positions	6
Number of Rows	1
PCB Mount Orientation	Vertical
PCB Mount Orientation  Body Features	Vertical

Black

Primary Product Color



Contact Mating Area Plating Material Thickness	2 μm[80 μin]
Contact Mating Area Plating Material Finish	Matte
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	9.5 A
Termination Features	
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	

Mating Alignment Type	Polarization
Mating Retention	With
PCB Mount Retention Type	Retention Leg
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	With

### **Housing Features**

Housing Material	Polyester GF
Centerline (Pitch)	3.81 mm[.15 in]

## Usage Conditions

Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
operating remperature range	33 103 O[ 07 ZZ1 1 ]

## Operation/Application

Circuit Application	Power & Signal	

## Industry Standards

UL Flammability Rating	UL 94V-0	
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## Packaging Features

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold



EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2022 (223) Candidate List Declared Against: JAN 2022 (223) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

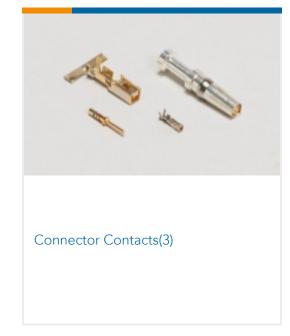
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## **Compatible Parts**

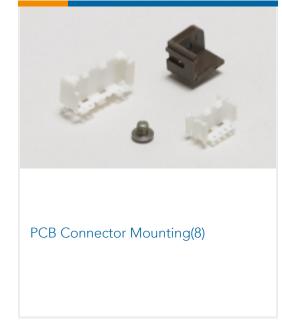


# Also in the Series | Dynamic 3000 Series



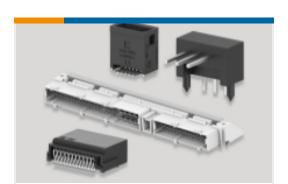






PCB Mount Header, Vertical, Wire-to-Board, 6 Position, .15 in [3.81 mm] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Dynamic 3000 Series





PCB Headers & Receptacles(283)



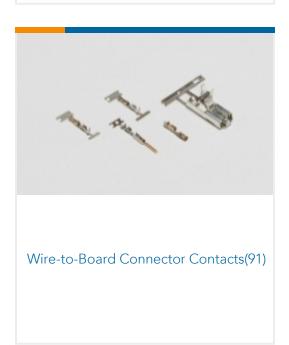
PCB Terminal Blocks(25)



Standard Rectangular Connectors(2)



Wire-to-Board Connector Assemblies & Housings(152)



## Customers Also Bought



TE Part #1-178128-5
DYNAMIC 3200 REC HSG 5P X



TE Part #178323-5 Header Assembly: Wire-to-Board, 15A, gold or tin plated



TE Part #1-178288-4
DYNAMIC 3100 REC HSG 4P



TE Part #1-178136-5 Header Assembly: Wire-to-Board, 15A, gold or tin plated





## **Documents**

14 wire size

### **Product Drawings**

DYNAMIC D3100 HDR ASSY 6P V K/X

English

#### **CAD Files**

3D PDF

English

Customer View Model ENG\_CVM\_1-178316-5\_C.2d\_dxf.zip

PCB Mount Header, Vertical, Wire-to-Board, 6 Position, .15 in [3.81 mm] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Dynamic 3000 Series



English

**Customer View Model** 

ENG\_CVM\_1-178316-5\_C.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_1-178316-5\_C.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

### Datasheets & Catalog Pages

1-1773732-4\_DYNAMIC\_SERIES\_CATALOG\_ENGLISH

Japanese

1-1773732-4\_DYNAMIC\_SERIES\_CATALOG\_ENGLISH

English

### **Product Specifications**

**Application Specification** 

English

#### **Agency Approvals**

**TUV Certificate** 

English